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#### **NEWS RELEASE**

## **SMIC Reports 2008 Third Quarter Results**

All currency figures stated in this report are in US Dollars unless stated otherwise. The financial statement amounts in this report are determined in accordance with US GAAP.

**Shanghai, China – October 29, 2008.** Semiconductor Manufacturing International Corporation (NYSE: SMI; SEHK: 981) ("SMIC" or the "Company"), one of the leading semiconductor foundries in the world, today announced its consolidated results of operations for the three months ended September 30, 2008.

#### Third Quarter 2008 Highlights:

- Overall revenue increased to \$375.9 million in 3Q08, up 9.6% from 2Q08. Specifically, advanced logic sales from 0.13 micron and 90 nanometer technology nodes have increased by 23.3% in 3Q08 quarter-on-quarter.
- Simplified average selling price ("ASP") increased by 2.1% from \$853 in 2Q08 to \$871 in 3Q08.
- Gross margin improved to 7.2% in 3Q08 compared to 6.1% in 2Q08.
- The Company reduced net loss to \$30.3 million in 3Q08 as compared to the net loss of \$45.6 million in 2Q08.

Commenting on the quarterly results, Dr. Richard Chang, Chief Executive Officer of SMIC remarked, "In terms of the third quarter performance, I am pleased to see a 9.6% quarter-over-quarter increase in the total revenue. The revenue growth is primarily due to higher logic demand as well as higher ASP from change in product mix. Our total logic wafer shipments in the third quarter increased 9.9% quarter-over-quarter and logic sales accounted for 87.4% of our total revenue in the third quarter. In terms of customers, revenue contribution from fabless customers increased by 10.5% quarter-over-quarter and 16.2% year-over-year. In terms of applications, we have experienced stronger sales in the communications sector, resulting in a 13.9% quarter-over-quarter increase in third quarter. In addition, sales in consumer applications also increased by 10.9% in the third quarter. DRAM as a percentage of our total revenue continued to decline to 2.4% in the third quarter. As a result of the depreciation and amortization expense of \$198 million, we recorded a net loss of \$30.3 million. Depreciation and amortization expense as a percentage of revenue decreased by 5% against the previous quarter. Moreover, starting 2009, the depreciation expense of our Shanghai 200mm facilities will drop to almost half within two years, which will further improve our bottom line. Our EBITDA margin improved from 42.5% in the second quarter to 45.5% in the third quarter.

During the third quarter, we continued to make progress in our key strategic initiatives. First, the conversion of DRAM capacity into logic is still on track with estimated completion by the end of this year. We expect that, once completed, our Beijing 300mm logic capacity at 2008 year-end will have increased more than 50% since the beginning of 2008.

In terms of our advanced technology node development, I am pleased to announce that SMIC has received all needed export licenses to enter into 32nm research and development in both logic and flash, starting January 1, 2009. In terms of our 65nm technology development, more than 20 products have already taped-out and are qualifying in different stages. Our 45nm collaboration with



IBM is on schedule in accordance to plan, and we expect to qualify the technology and begin risk production in the second half of 2009.

We are pleased to see our Chinese customers making strong progress and advancing their technology nodes. Our China shipment quantity grew 28% in the third quarter, and our greater China revenue contributed to 31% of our overall revenue in the third quarter. As we have announced previously, as a result of technology collaboration with us, one of our Chinese customers successfully introduced the demodulator chip for China's high-definition TV application. This was the first and the most comprehensive chip solution on the Chinese DTV market. In addition, another Chinese customer introduced mobile TV solutions based on th



300-mm logic capacity by the end of 2008, the expected timing for qualifying our technology and risk production in connection with our 45nm collaboration with IBM, the expected expansion of TD-SCDMA to another 28 cities in the near future, future collaborations with local fabless design houses, our intention to hold back on capacity expansion, our expectation for fourth quarter 2008 revenue, and statements under "Capex Summary" and "Fourth Quarter 2008 Guidance", are based on SMIC's current assumptions, expectations and projections about future events. SMIC uses words like "believe," "anticipate," "intend," "estimate," "expect," "project" and similar expressions to identify forward-looking statements, although not all forward-looking statements contain these words. These forward-looking statements are necessarily estimates reflecting the best judgment of SMIC's senior management and involve significant risks, both known and unknown, uncertainties and other factors that may cause SMIC's actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with cyclicality and market conditions in the semiconductor industry, the current global financial crisis, intense competition, timely wafer acceptance by SMIC's customers, timely introduction of new technologies, SMIC's ability to ramp new products into volume, supply and demand for semiconductor foundry services, industry overcapacity, shortages in equipment, components and raw materials, orders or judgments from pending litigation, availability of manufacturing capacity and financial stability in end markets.

Investors should consider the information contained in SMIC's filings with the U.S. Securities and Exchange Commission (SEC), including its annual report on 20-F, as amended, filed with the SEC on June 27, 2008, especially in the "Risk Factors" and "Management's Discussion and Analysis of Financial Condition and Results of Operations" sections, and such other documents that SMIC may file with the SEC or SEHK from time to time, including on Form 6-K. Other unknown or unpredictable factors also could have material adverse effects on SMIC's future results, performance or achievements. In light of these risks, uncertainties, assumptions and factors, the forward-looking events discussed in this press release may not occur. You are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date stated, or if no date is stated, as of the date of this press release. Except as required by law, SMIC undertakes no obligation and does not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

#### **Material Litigation**

Recent TSMC Legal Developments:

On August 25, 2006, TSMC filed a lawsuit against the Company and certain subsidiaries (SMIC (Shanghai), SMIC (Beijing) and SMIC (Americas)) in the Superior Court of the State of California, County of Alameda for alleged breach of the Settlement Agreement, alleged breach of promissory notes and alleged trade secret misappropriation by the Company. TSMC seeks, among other things, damages, injunctive relief, attorneys' fees, and the acceleration of the remaining payments outstanding under the Settlement Agreement.

In the present litigation, TSMC alleges that the Company has incorporated TSMC trade secrets in the manufacture of the Company's 0.13 micron or smaller process products. TSMC further alleges that as a result of this claimed breach, TSMC's patent license is terminated and the covenant not to sue is no longer in effect with respect to the Company's larger process products.

The Company has vigorously denied all allegations of misappropriation. The Court has made no finding that TSMC's claims are valid, nor has it set a trial date.

On September 13, 2006, the Company announced that in addition to filing a response strongly denying the allegations of TSMC in the United States lawsuit, it filed on September 12, 2006, a cross-complaint against TSMC seeking, among other things, damages for TSMC's breach of contract and breach of implied covenant of good faith and fair dealing.



On November 16, 2006, the High Court in Beijing, the People's Republic of China, accepted the filing of a complaint by the Company and its wholly-owned subsidiaries, SMIC (Shanghai) and SMIC (Beijing), regarding the unfair competition arising from the breach of bona fide (i.e. integrity, good faith) principle and commercial defamation by TSMC ("PRC Complaint"). In the PRC Complaint, the Company is seeking, among other things, an injunction to stop TSMC's infringing acts, public apology from TSMC to the Company and compensation from TSMC to the Company, including profits gained by TSMC from their infringing acts.

TSMC filed with the California court in January 2007 a motion seeking to enjoin the PRC action. In February 2007, TSMC filed with the Beijing High Court a jurisdictional objection, challenging the competency of the Beijing High Court's jurisdiction over the PRC action.

In March 2007, the California Court denied TSMC's motion to enjoin the PRC action. TSMC appealed this ruling to California Court of Appeal. On March 26, 2008, the Court of Appeal, in a written opinion, denied TSMC's appeal.

In July 2007, the Beijing High Court denied TSMC's jurisdictional objection and issued a court order holding that the Beijing High Court shall have proper jurisdiction to try the PRC action. TSMC appealed this order to the Supreme Court of the People's Republic of China. On January 7, 2008, the Supreme Court heard TSMC's appeal. On June 13, 2008, the Supreme Court denied TSMC's appeal



information to become available to us which will aid us in making a determination. The outcome of any impairment analysis performed under SFAS 144 might result in a material impact to our financial position and results of operations. Because the case is in its preliminary stages, the Company is unable to evaluate the likelihood of an unfavorable outcome or to estimate the amount or range of potential loss.



# **Summary of Third Quarter 2008 Operating Results**

Amounts in US\$ thousands, except for EPS and operating data

3Q08 2Q08 QoQ



- R&D expenses decreased to \$17.8 million in 3Q08, down 52.7% from \$37.7 million, primarily due to an increase in government subsidies received in 3Q08.
- G&A expenses decreased to \$10.8 million in 3Q08 from \$13.3 million in 2Q08 primarily due to a decrease in legal expenses.
- Selling & marketing expenses increased to \$5.6 million in 3Q08, up 28.1% QoQ from \$4.4 million in 2Q08, primarily due to certain tax expenses in connection with the selling activities.



# **Analysis of Revenues**

| Sales Analysis                            |       |       |       |
|---|-------|-------|-------|
| By Application                            | 3Q08  | 2Q08  | 3Q07  |
| Computer                                  | 5.4%  | 7.9%  | 22.7% |
| Communications                            | 53.0% | 51.1% | 50.0% |
| Consumer                                  | 32.8% | 32.4% | 18.3% |
| Others                                    | 8.8%  | 8.6%  | 9.0%  |
| By Service Type                           | 3Q08  | 2Q08  | 3Q07  |
| Logic <sup>(3)</sup>                      | 87.4% | 85.7% | 66.8% |
| DRAM                                      | 2.3%  | 3.6%  | 23.6% |
| Management services                       | 2.4%  | 2.6%  | 3.1%  |
| Mask making, testing, others              | 7.9%  | 8.1%  | 6.5%  |
| By Customer Type                          | 3Q08  | 2Q08  | 3Q07  |
| Fabless semiconductor companies           | 55.1% | 54.6% | 45.5% |
| Integrated device manufacturers (IDM)     | 26.1% | 25.7% | 40.0% |
| System companies and others               | 18.8% | 19.7% | 14.5% |
| By Geography                              | 3Q08  | 2Q08  | 3Q07  |
| North America                             | 58.6% | 55.1% | 44.7% |
| Asia Pacific (ex. Japan)                  | 34.6% | 34.7% | 26.4% |
| Japan                                     | 2.1%  | 3.6%  | 10.1% |
| Europe                                    | 4.7%  | 6.6%  | 18.8% |
| Wafer Revenue Analysis                    |       |       |       |
| By Technology (Logic, DRAM &              |       |       |       |
| copper interconnect only)                 | 3Q08  | 2Q08  | 3Q07  |
| 0.09µm                                    | 19.4% | 18.4% | 26.7% |
| 0.13µm                                    | 25.1% | 22.9% | 28.6% |
| 0.15µm                                    | 2.0%  | 2.1%  | 2.0%  |
| 0.18µm                                    | 33.9% | 37.7% | 28.8% |
| 0.25µm                                    | 0.5%  | 0.6%  | 1.0%  |
| 0.35µm                                    | 19.1% | 18.3% | 12.9% |
| By Technology (Logic Only) <sup>(1)</sup> | 3Q08  | 2Q08  | 3Q07  |
| 0.09µm                                    | 19.4% | 16.4% | 13.7% |
| 0.13µm <sup>(2)</sup>                     | 23.2% | 21.8% | 22.7% |
| 0.15µm                                    | 2.0%  | 2.2%  | 2.7%  |
| 0.18µm                                    | 35.0% | 39.6% | 41.0% |
| 0.25µm                                    | 0.5%  | 0.6%  | 1.4%  |
| 0.35µm                                    | 19.9% | 19.4% | 18.5% |

<sup>(1)</sup> Excluding 0.13μm copper interconnects
(2) Represents revenues generated from manufacturing full flow wafers
(3) Including 0.13μm copper interconnects



#### Capacity\*

| Fab / (Wafer Size)                       | 3Q08    | 2Q08    |
|--|---------|---------|
|  |         |         |
| Shanghai Mega Fab (8")                   | 88,000  | 86,000  |
| Beijing Mega Fab (12")                   | 36,000  | 40,500  |
| Tianjin Fab (8")                         | 30,000  | 28,000  |
| Total monthly wafer fabrication capacity | 154,000 | 154,500 |
|  |         |         |

#### Note:

# **Shipment and Utilization**

| 8" equivalent wafers                           | 3Q08    | 2Q08    | 3Q07    |
|--|---------|---------|---------|
| Wafer shipments including copper interconnects | 431,660 | 402,114 | 458,466 |
| Utilization rate <sup>(1)</sup>                | 90.5%   | 92.2%   | 94.1%   |

#### Note:

(1) Capacity utilization based on total wafer out divided by estimated capacity

- Wafer shipments increased 7.3% QoQ to 431,660 units of 8-inch equivalent wafers in 3Q08 from 402,114 units of 8-inch equivalent wafers in 2Q08, and down 5.8% YoY from 458,466 8-inch equivalent wafers in 3Q07.
- Logic shipments increased by 9.9% QoQ to 396,169 units of 8-inch equivalent wafers in 3Q08 from 2Q08 and up 32.1% YoY from 3Q07.

<sup>\*</sup> Wafers per month at the end of the period in 8" wafers



### **Detailed Financial Analysis**

#### **Gross Profit Analysis**

| Amounts in US\$ thousands  | 3Q08    | 2Q08    | QoQ    | 3Q07    | YoY    |
|----------------------------|---------|---------|--------|---------|--------|
| Cost of sales              | 348,721 | 322,077 | 8.3%   | 349,148 | -0.1%  |
| Depreciation               | 165,641 | 153,783 | 7.7%   | 151,720 | 9.2%   |
| Other manufacturing costs  | 176,329 | 160,938 | 9.6%   | 189,069 | -6.7%  |
| Deferred cost amortization | 5,886   | 5,886   |        | 5,886   |        |
| Share-based compensation   | 865     | 1,470   | -41.2% | 2,473   | -65.0% |
| Gross Profit               | 27,224  | 20,842  | 30.6%  | 42,250  | -35.6% |
| Gross Margin               | 7.2%    | 6.1%    |        | 10.8%   |        |

- Cost of sales increased to \$348.7 million in 3Q08, up 8.3% QoQ from \$322.1 million in 2Q08.
- Gross profit increased to \$27.2 million in 3Q08, up 30.6% QoQ from \$20.8 million in 2Q08 and down 35.6% YoY from \$42.3 million in 3Q07.
- Gross margins increased to 7.2% in 3Q08 from 6.1% in 2Q08.

## Operating Expense Analysis

| Amounts in US\$ thousands                 | 3Q08   | 2Q08    | QoQ    | 3Q07   | YoY    |
|---|--------|---------|--------|--------|--------|
| Total operating expenses                  | 40,451 | 60,750  | -33.4% | 62,435 | -35.2% |
| Research and development                  | 17,838 | 37,684  | -52.7% | 25,906 | -31.1% |
| General and administrative                | 10,761 | 13,328  | -19.3% | 23,836 | -54.9% |
| Selling and marketing                     | 5,578  | 4,356   | 28.1%  | 4,901  | 13.8%  |
| Amortization of intangible assets         | 6,906  | 6,899   | 0.1%   | 7,751  | -10.9% |
| (Income) Loss from disposal of properties | (632)  | (1,517) | -      | 41     | -      |

- Total operating expenses decreased to \$40.5 million in 3Q08 from \$60.8 million, a decrease
  of 33.4% QoQ primarily due to a decrease in both research & development expenses and
  general administrative expenses.
- R&D expenses decreased to \$17.8 million in 3Q08, down 52.7% from \$37.7 million primarily due to an increase in government subsidies received in 3Q08.
- G&A expenses decreased to \$10.8 million in 3Q08 from \$13.3 million in 2Q08 due to a decrease in legal expenses.
- Selling & marketing expenses increased to \$5.6 million in 3Q08, up 28.1% QoQ from \$4.4 million in 2Q08, primarily due to certain tax expenses in connection with the selling activities.



#### Other Income (Expenses)

| Amounts in US\$ thousands | 3Q08     | 2Q08     | QoQ    | 3Q07     | YoY    |
|---------------------------|----------|----------|--------|----------|--------|
| Other expenses            | (15,631) | (5,193)  | 201.0% | (4,342)  | 260.0% |
| Interest income           | 2,542    | 4,059    | -37.4% | 2,819    | -9.8%  |
| Interest expense          | (11,088) | (15,279) | -27.4% | (14,791) | -25.0% |
| Other, net                | (7,085)  | 6,027    | -      | 7,629    | -      |

- Interest expense decreased in 3Q08 as compared to 2Q08 due to a lower average loan balance as well as an increase in the capitalized interest.
- The increase in Other, net is due primarily to a a foreign exchange loss of \$7.0 million related to non-operating activities recorded in 3Q08 as compared to a gain of \$2.5 million in 2Q08. Combined with the foreign exchange gain from operating activities, the company recorded total foreign exchange loss of \$4.6 million in 3Q08 as compared to a gain of \$7.8 million in 2Q08.

# Liquidity

| Amounts in US\$ thousands         | 3Q08      | 2Q08      |
|-----------------------------------|-----------|-----------|
|                                   |           |           |
| Cash and cash equivalents         | 392,881   | 480,265   |
| Restricted cash                   | 3,000     | 91,130    |
| Short term investments            | 50,646    | 32,326    |
| Accounts receivable               | 285,874   | 262,418   |
| Inventory                         | 233,022   | 252,394   |
| Others                            | 72,272    | 64,767    |
| Total current assets              | 1,037,695 | 1,183,300 |
| Accounts payable                  | 301,712   | 345,801   |
| Short-term borrowings             | 212,600   | 242,908   |
| Current portion of long-term debt | 340,355   | 341,630   |
| Others                            | 177,736   | 159,958   |
| Total current liabilities         | 1,032,403 | 1,090,297 |
| Cash Ratio                        | 0.3x      | 0.5x      |
| Quick Ratio                       | 0.7x      |           |
| Current Ratio                     | 1.0x      |           |



# Capital Structure

| Amounts in US\$ thousands          | 3Q08    | 2Q08    |
|------------------------------------|---------|---------|
|                                    |         |         |
| Cash and cash equivalents          | 392,881 | 480,265 |
| Restricted cash                    | 3,000   | 91,130  |
| Short-term investment              | 50,646  | 32,326  |
|                                    |         |         |
| Current portion of promissory note | 29,493  | 29,242  |
| Promissory note                    | 37,762  |         |



- Operating expense as a percentage of revenue expected to be around the mid-teens. Capital expenditure expected to be approximately \$165 million to \$195 million.



#### **Recent Highlights and Announcements**

- SMIC Reiterates 2008 Third Quarter Revenue Guidance [2008-9-28]
- SMIC S2/FAB 8 passes the ISO 27001 Information Security Management System Certification [2008-9-26]
- SMIC 2008 Technology Symposium held in Shanghai [2008-9-19]
- Announcement of Unaudited Interim Results for the Six Months Ended June 30, 2008 [2008-9-19]
- Spansion Extends SMIC Agreement to Include 43nm MirrorBit ORNAND2 Technology [2008-8-21]
- SMIC President and CEO Dr. Richard Chang to Run Anchor Leg of Beijing Economic and Technical Development Area Portion of Olympic Torch Relay [2008-8-8]
- Telepath Collaborated with Infineon and SMIC to Successfully Enable Diverse Mobile TV Devices for the 2008 Summer Olympic Games [2008-8-4]
- SMIC Reports Results for the Three Months Ended June 30, 2008 [2008-7-28]

Please visit SMIC's website at http://www.smics.com/website/enVersion/Press\_Center/pressRelease.jsp for further details regarding the recent announcements.



#### Semiconductor Manufacturing International Corporation BALANCE SHEET (In US dollars)



# Semiconductor Manufacturing International Corporation CONSOLIDATED STATEMENT OF OPERATIONS (In US dollars)

|   | For the three months ended |                           |    | s ended                      |
|---|----------------------------|---------------------------|----|------------------------------|
|   |                            | ep 30, 2008<br>inaudited) | J  | June 30, 2008<br>(unaudited) |
| Sales   | \$                         | 375,944,833               | \$ | 342,919,148                  |
| Cost of sales   |                            | 348,720,498               |    | 322,076,702                  |
| Gross profit  |                            | 27,224,335                |    | 20,842,446                   |
| Operating expenses:   |                            |                           |    |                              |
| Research and development  |                            | 17,838,076                |    | 37,684,073                   |
| General and administrative  |                            | 10,760,722                |    | 13,328,153                   |
| Selling and marketing   |                            | 5,578,365                 |    | 4,356,161                    |
| Amortization of acquired intangible assets                                    |                            | 6,906,344                 |    | 6,898,279                    |
| Income from sale of plant and equipment and other fixed assets                |                            | (632,029)                 |    | (1,516,754)                  |
| Total operating expenses  |                            | 40,451,478                |    | 60,749,912                   |
| Loss from operations  |                            | (13,227,143)              |    | (39,907,466)                 |
| Other income (expenses):  |                            |                           |    |                              |
| Interest income   |                            | 2,541,743                 |    | 4,058,901                    |
| Interest expense  |                            | (11,087,893)              |    | (15,279,685)                 |
| Foreign currency exchange (loss) gain   |                            | (7,022,913)               |    | 2,478,287                    |
| Other income, net   |                            | (62,216)                  |    | 3,549,159                    |
| Total other expenses, net   |                            | (15,631,279)              |    | (5,193,338)                  |
| Net loss before income tax, minority interest and loss from equity investment |                            | (28,858,422)              |    | (45,100,804)                 |
| Income tax expense  |                            | (4,499,387)               |    | (2,046,464)                  |
| Minority interest   |                            | 3,094,474                 |    | 1,602,964                    |
| Loss from equity investment   |                            | (25,803)                  |    | (85,122)                     |
| Net loss  | \$                         | (30,289,138)              | \$ | (45,629,426)                 |
| Net loss per share, basic   |                            | (0.0016)                  |    | (0.0025)                     |
| Net loss per ADS, basic   |                            | (0.0814)                  |    | (0.1227)                     |
| Net loss per share, diluted   |                            | (0.0016)                  |    | (0.0025)                     |
| Net loss per ADS, diluted   |                            | (0.0814)                  |    | (0.1227)                     |
| Ordinary shares used in calculating basic loss per ordinary share             |                            | 18,612,441,880            |    | 18,589,202,067               |
| Ordinary shares used in calculating diluted loss per ordinary share           |                            | 18,612,441,880            |    | 18,589,202,067               |



#### Semiconductor Manufacturing International Corporation CONSOLIDATED STATEMENT OF CASH FLOWS (In US dollars)

|  | For the three months ended |               |                 |  |
|--|----------------------------|---------------|-----------------|--|
|  | Se                         | ep 30, 2008   | June 30, 2008   |  |
|  | (ı                         | inaudited)    | (unaudited)     |  |
| Operating activities                                   |                            |               |                 |  |
| Net loss   | \$                         | (30,289,138)  | \$ (45,629,426) |  |
| Adjustments to reconcile net loss to net cash provided |                            |               |                 |  |
| by (used in) operating activities:                     |                            |               |                 |  |
| Minority interest                                      |                            | (3,094,474)   | (1,602,964)     |  |
| Deferred tax   |                            | 511,663       | (6,223,931)     |  |
| Gain on disposal of plant and equipment                |                            | (632,029)     | (1,516,754)     |  |
| Depreciation and amortization                          |                            | 188,387,781   | 187,912,371     |  |
| Amortization of acquired intangible assets             |                            | 6,931,344     | 6,898,279       |  |
| Share-based compensation                               |                            | 2,368,706     | 3,293,295       |  |
| Non cash interest expense on promissory notes          |                            | 1,522,485     | 1,839,073       |  |
| Loss from equity investment                            |                            | 25,803        | 85,122          |  |
| Changes in operating assets and liabilities:           |                            |               |                 |  |
| Accounts receivable, net                               |                            | (23,455,351)  | 21,513,042      |  |
| Inventories  |                            | 19,371,201    | (36,234,839)    |  |
| Prepaid expense and other current assets               |                            | (9,608,778)   | (6,011,332)     |  |
| Accounts payable                                       |                            | (57,377,721)  | 33,225,078      |  |
| Accrued expenses and other current liabilities         |                            | 15,422,174    | (10,301,330)    |  |
| Income tax payable                                     |                            | 35,418        | (34,187)        |  |
| Net cash provided by operating activities              |                            | 110,119,084   | 147,211,497     |  |
| Investing activities:                                  |                            |               |                 |  |
| Purchase of plant and equipment                        |                            | (220,937,580) | (204,346,529)   |  |
| Proceeds from disposal of plant and equipment          |                            | 3,920,056     | 9,157           |  |
| Proceeds received from sale of assets held for sale    |                            | 1,004,594     | 642,452         |  |
| Purchases of acquired intangible assets                |                            | (14,670,000)  | (22,443,824)    |  |
| Purchase of short-term investments                     |                            | (154,185,792) | (94,846,471)    |  |
| Purchase of equity investment                          |                            | (1,900,000)   | -               |  |
| Sale of short-term investments                         |                            | 135,865,909   | 91,994,718      |  |
| Change in restricted cash                              |                            | 88,129,665    | (91,129,665)    |  |
| Net cash used in investing activities                  |                            | (162,773,148) | (320,120,162)   |  |
| Financing activities:                                  |                            |               |                 |  |
| Proceeds from short-term borrowing                     |                            | 84,680,413    | 208,437,613     |  |
| Proceeds from long-term debt                           |                            | -             | 227,024,023     |  |
| Repayment of promissory notes                          |                            | _             | (15,000,000)    |  |
| Repayment of long-term debt                            |                            | (4,435,051)   | (170,780,962)   |  |
| Repayment of short-term debt                           |                            | (114,987,613) | (103,000,000)   |  |
| Proceeds from exercise of employee stock options       |                            | 74,176        | 246,496         |  |
| Net cash (used in) provided by financing activities    |                            | (34,668,075)  | 146,927,170     |  |
| Effect of exchange rate changes                        |                            | (62,231)      | (73,428)        |  |
| NET DECREASE IN CASH AND CASH EQUIVALENTS              |                            | (87,384,370)  | (26,054,923)    |  |



# Semiconductor Manufacturing International Corporation CONSOLIDATED STATEMENT OF CASH FLOWS (In US dollars)

| CASH AND CASH EQUIVALENTS, beginning of period | 480,265,390 | 506,320,313 |
|--|-------------|-------------|
| CASH AND CASH EQUIVALENTS, end of period       | 392,881,020 | 480,265,390 |